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- Fully Parallel 4-Bit ALU in 20-Pin Package
- Ideally Suited for High-Density Economical **Processors**
- Ripple-Carry (C_{n+4}) and Overflow (OVR) **Outputs**
- Arithmetic and Logic Operations Selected Specifically to Simplify System Implementation:

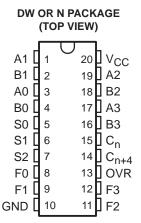
A Minus B

B Minus A

A Plus B

Five Other Functions

 Package Options Include Plastic **Small-Outline Packages and Standard** Plastic 300-mil DIPs



description

The SN74F382 is an arithmetic logic unit (ALU)/function generator that performs eight binary arithmetic/logic operations on two 4-bit words as shown in the function table. The exclusive-OR, AND, and OR functions of the two Boolean variables are provided without the use of external circuits. In addition, the outputs can be cleared (low) or preset (high) as desired. The device provides a ripple-carry (C_{n+4}) output to ripple the carry to the C_n input of the next stage. It detects and indicates the two's complement overflow condition via the overflow (OVR) output. OVR is logically equivalent to $C_{n+3} \oplus C_{n+4}$. When the SN74F382 is cascaded to handle word lengths longer than four bits in length, only the most significant OVR is used.

The SN74F382 is characterized for operation from 0°C to 70°C.

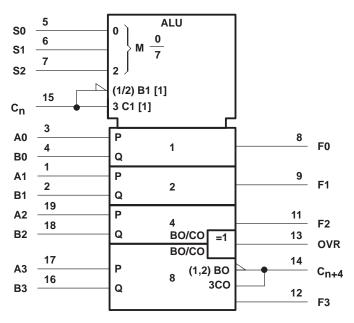
FUNCTION TABLE

SI	ELECTIO	N	ARITHMETIC/LOGIC
S2	S1	S0	OPERATION
L	L	L	Clear
L	L	Н	B minus A
L	Н	L	A minus B
L	Н	Н	A plus B
Н	L	L	$A \oplus B$
Н	L	Н	A + B
Н	Н	L	AB
Н	Н	Н	Preset

PIN DESIGNATIONS

DESIGNATION	PIN NO.	FUNCTION
A3, A2, A1, A0	17, 19, 1, 3	Word A inputs
B3, B2, B1, B0	16, 18, 2, 4	Word B inputs
S2, S1, S0	7, 6, 5	Function-select inputs
C _n	15	Carry input for addition, inverted carry input for subtraction
F3, F2, F1, F0	12, 11, 9, 8	Function outputs
C _{n+4}	14	Ripple-carry output
OVR	13	Overflow output
Vcc	20	Supply voltage
GND	10	Ground

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

function table

Certain differences exist in the OVR and C_{n+4} function table compared with similar parts from other technologies and other vendors. No differences exist in the arithmetic modes (B minus A, A minus B, and A plus B) where these outputs perform valuable cascade functions. There are slight differences in the other modes (clear, A + B, A \oplus B, AB, and preset), in which these outputs strictly *don't care*.

The following function table is a condensed version and assumes for A_n that A0, A1, A2, and A3 inputs all agree, and for B_n that B0, B1, B2, and B3 inputs all agree. This table is intended to point out the response of these OVR and C_{n+4} outputs in all modes of operation to facilitate incoming inspection.

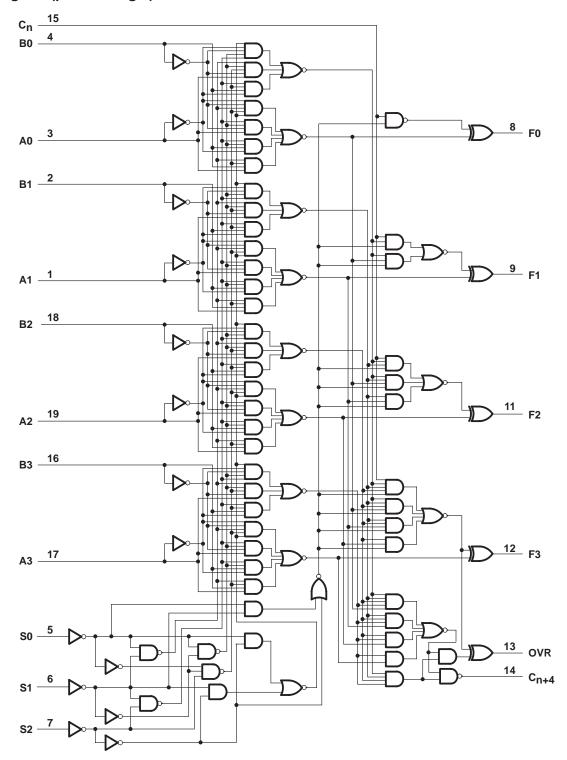


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FUNCTION TABLE

ARITHMETIC/LOGIC			INP	UTS			OUTPUTS					_
OPERATION	S2	S1	S0	Cn	An	B _n	F3	F2	F1	F0	OVR	C _{n+4}
Clear	L	L	L	Χ	Χ	Χ	L	L	L	L	Н	Н
B minus A	L	L	Н	L L L	L H H	L H L H	H H L	H H L H	H H L H	H L L	L L L	L H L
				H H H	L L H	L H L	L H L	L H L	L H L	L H H L	L L L	H L H
A minus B	L	Н	L	L L H H H	L H H L H	L H L H L	H H H L H L	H H H L H	H H H L H	H L H L H		L H L H H
A plus B	L	Н	н		L H H L H H	L H L H L	L H H L L L H	L H H L L	L H H L L	L H L L H		L L H L H
A ⊕ B	Н	L	L	X X L H	L H H	L H L L	L H H L	L H H L	L H H L	L H H L	L L H	L L H
A + B	Н	L	Н	X X X L	L H H	L H L H	L H H H	L H H H	L H H H	L H H H	L L L	L L L H
АВ	Н	Н	L	X X L H	L H H	L H L H	L L H H	L L H H	L L H H	L L H H	H L H L	H L H L
Preset	Н	Н	Н	X X X L	L H H	L H L H	H H H H H	H H H H	H H H H	H H H H	L L L H	L L L H

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	1.2 V to 7 V
Input current range	30 mA to 5 mA
Voltage range applied to any output in the high state	0.5 V to V _{CC}
Current into any output in the low state	40 mA
Operating free-air temperature range	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
V _{IL}	Low-level input voltage			8.0	V
lıK	Input clamp current			-18	mA
ІОН	High-level output current			- 1	mA
l _{OL}	Low-level output current			20	mA
TA	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS		MIN	TYP [‡]	MAX	UNIT
VIK		$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.2	V
V		$V_{CC} = 4.5 \text{ V},$	I _{OH} = – 1 mA	2.5	3.4		\/
VOH		$V_{CC} = 4.75 \text{ V},$	I _{OH} = – 1 mA	2.7			٧
VOL		$V_{CC} = 4.5 \text{ V},$	$I_{OL} = 20 \text{ mA}$		0.3	0.5	V
lį		V _{CC} = 5.5 V,	V _I = 7 V			0.1	mA
lιΗ		V _{CC} = 5.5 V,	V _I = 2.7 V			20	μΑ
	Any A or B					- 2.4	
IĮL	Any S	V _{CC} = 5.5 V,	V _I = 0.5 V			- 0.6	mA
	C _n					-3	
los§		V _{CC} = 5.5 V,	VO = 0	-60		-150	mA
lcc		V _{CC} = 5.5 V,	See Note 2		54	81	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.

[§] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: I_{CC} is measured with all outputs open, S0 and C_n inputs at 4.5 V, and all other inputs grounded.

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switching characteristics (see Note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _I	CC = 5 V _ = 50 pl _ = 500 s _ = 25°C	F, Ω,	V _{CC} = 4.5 C _L = 50 pl R _L = 500 Ω T _A = MIN	2,	UNIT
			MIN	TYP	MAX	MIN	MAX	
t _{PLH}	C	Any F	2.3	5.3	11	2.3	12	
t _{PHL}	C _n	Ally F	2.2	4.6	7.5	2.2	8.5	ns
^t PLH	A A D	Δ	2.7	6.9	12	2.4	13	
^t PHL	Any A or B	Any F	2.5	6.1	10	2.3	11	ns
^t PLH	00 04 00	A =	4.7	8.3	15	4.3	17	ns
^t PHL	S0, S1, S2	Any F	3.3	7.5	14	3.3	15	
t _{PLH}	A A D		3.3	6.6	10	3.3	11	ns
t _{PHL}	Any A or B	C _{n+4}	3.4	6.3	10	3	10.5	
^t PLH	00 04 00	OVP C	3.6	9.8	16.5	3	17.5	ns
^t PHL	S0, S1, S2	OVR or C _{n+4}	5	8.6	13	4.6	14	
^t PLH			2.2	3.9	5.5	2	6.5	ns
t _{PHL}	C _n	C _{n+4}	3	4.8	6.5	2.6	7.5	
t _{PLH}		01/5	3.3	7	11	3	12.5	ns
t _{PHL}	C _n	OVR	3	5	6.5	3	8	
tPLH	A A D	OVP.	5.1	8.8	13	4.7	15	20
t _{PHL}	Any A or B	OVR	3.3	6.9	10.5	3.3	11.5	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 3: Load circuits and waveforms are shown in Section 1.







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PACKAGING INFORMATION

Ordera	able Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN	74F382N	OBSOLETE	PDIP	N	20	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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